



Recommended P.C.B. Layout  
Layout Tolerance = ± 0.05 mm

NOTE:

- MATERIAL,  
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK  
TERMINAL: COPPER ALLOY , SQ=0.40±0.03MM
- FINISH:  
TERMINAL: GOLD AT CONTACT,  
G/F OVER 1um(40u")MIN Ni OVER ALL
- SPEC.:  
PRODUCT SPEC: GS-12-629  
PACKING SPEC: GS-14-1420
- THE HSG. WILL WITHSTAND EXPOSURE TO 260C  
PEAK TEMP. FOR 5 SEC. IN A WAVE SOLDER APPLICATION  
WITH A PCB.
- PRODUCT NUMBERING:  
20021111 - 0 0 0 XX X X LF

LEAD FREE  
PLATING:  
1: GOLD FLASH ALL OVER  
4: 0.25um(10u")GOLD AT CONTACT  
8: 0.76um(30u")GOLD AT CONTACT  
PACKING  
T: TUBE  
  
PIN COUNT  
06,08,10,...., 98,A0  
( 6 -100 EVERY EVEN PIN )

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mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY	FCI www.fciconnect.com		
ltr	ecn no	dr	date	linear	.X ± 0.38	projection	title		
A	T09-1117	S.LIN	09/15/09		.XX ± 0.25		1.27X1.27MM BTB,HEADER		
B	T10-0011	S.LIN	01/22/10	angles	.XXX ± 0.10	MM	UNSHROUDED,VERTICAL,TH		
				0° ±2°			product family	585	code
				dr	STERLING LIN	09/15/09	size	dwg no	TWN
				engr	STERLING LIN	09/15/09	scale	A4	sheet
				chr	GARY HSIEH	09/15/09	NA	20021111	1 of 1
				appd	JOSEPH HSIA	09/15/09			
sheet index	revision sheet	B	1						